



# 40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
	13.7mΩ @ V <sub>GS</sub> = 10V	49.8A
40V	26mΩ @ V <sub>GS</sub> = 4.5V	36.7A

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

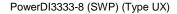
- Backlighting
- Power Management Functions
- DC-DC Converters

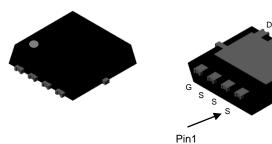
## **Features and Benefits**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- Low R<sub>DS(ON)</sub> Ensures On State Losses are Minimized
- Excellent Q<sub>qd</sub> x R<sub>DS</sub> (ON) Product (FOM)
- Wettable Flank for Improved Optical Inspection
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>

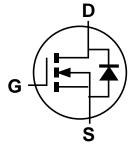
#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe;
   Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)









**Equivalent Circuit** 

#### Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH4014LFVW-7	PowerDI3333-8 (SWP) (Type UX)	2,000/Tape & Reel
DMTH4014LFVW-13	PowerDI3333-8 (SWP) (Type UX)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**



H4W = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 20 = 2020)

WW = Week Code (01 to 53)



## **Maximum Ratings** (@T<sub>A</sub> =+ 25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	40	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Note 6), V <sub>GS</sub> = 10V	Tc = +25°C Tc = +100°C	ID	49.8 35.2	А
Continuous Drain Current (Note 5), $V_{GS} = 10V$ $T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$		lo	11.5 8.1	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	180	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	45	Α	
Pulsed Body Diode Forward Current (10μs Pulse, Duty Cycle	Isм	180	Α	
Avalanche Current, L=0.1mH	las	19.8	Α	
Avalanche Energy, L=0.1mH	E <sub>AS</sub>	19.6	mJ	

#### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P <sub>D</sub>	3.1	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	48.6	°C/W	
Total Power Dissipation (Note 6)	PD	57.7	W	
Thermal Resistance, Junction to Case (Note 6)		R <sub>0</sub> JC	2.5	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C	

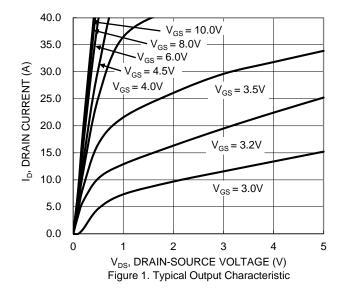
## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

		-			-		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS		_	1	μΑ	V <sub>DS</sub> = 32V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	1	_	3	<b>V</b>	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Decrees	-	9.8	13.7	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	RDS(ON)		14.5	26	11122	$V_{GS} = 4.5V, I_{D} = 10A$	
Diode Forward Voltage	VsD	_	0.9	1.2	V	Vgs = 0V, Is = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	750	_		V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss	_	225	_	pF		
Reverse Transfer Capacitance	Crss	_	21	_			
Gate Resistance	Rg	_	1.1	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	5.7	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	11.2	_	nC	V <sub>DS</sub> = 20V, I <sub>D</sub> = 20A	
Gate-Source Charge	Qgs	_	2.0	_	iiC		
Gate-Drain Charge	Qgd	_	2.2	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.5	_		$V_{DD} = 20V, V_{GS} = 10V,$ $R_g = 1.6\Omega, I_D = 20A$	
Turn-On Rise Time	t <sub>R</sub>	_	4.6	_	20		
Turn-Off Delay Time	t <sub>D</sub> (OFF)	_	12.4	_	ns		
Turn-Off Fall Time	tr	_	4.9	_			
Body Diode Reverse Recovery Time	trr	_	11.3	_	ns	1 454 41/41 4004/	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	9.5	_	$\frac{1}{1}$ IF = 15A, di/dt = 400A/µs		

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 6. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.





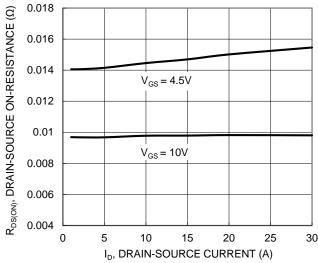


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

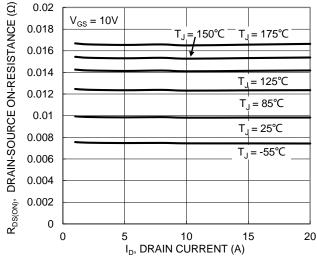
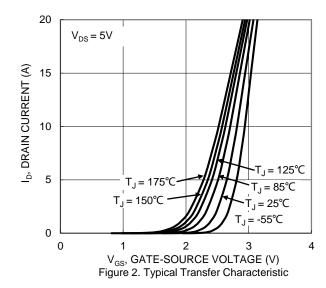
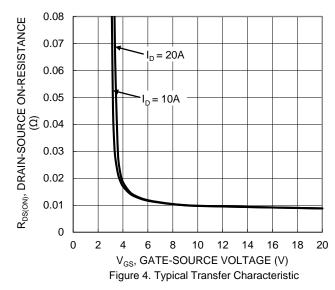


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





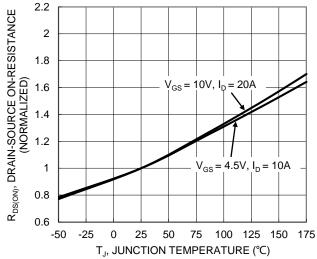


Figure 6. On-Resistance Variation with Junction Temperature



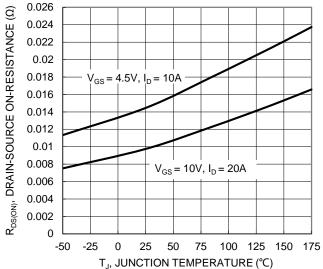
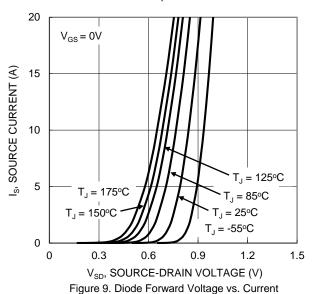


Figure 7. On-Resistance Variation with Junction Temperature



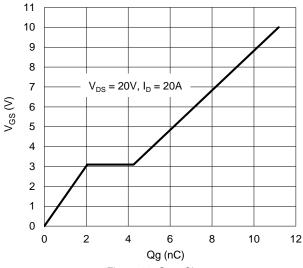


Figure 11. Gate Charge

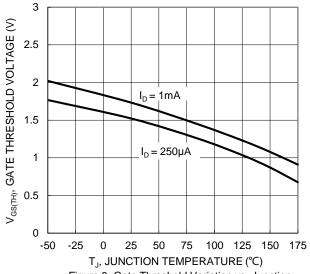
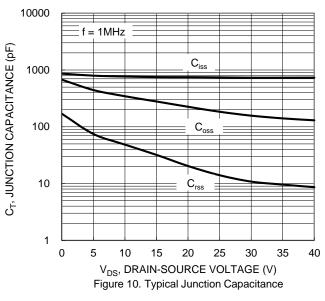
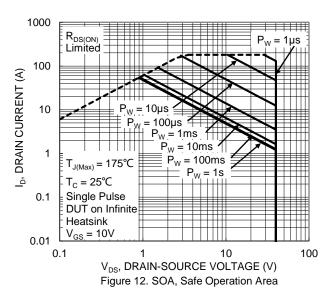


Figure 8. Gate Threshold Variation vs. Junction Temperature







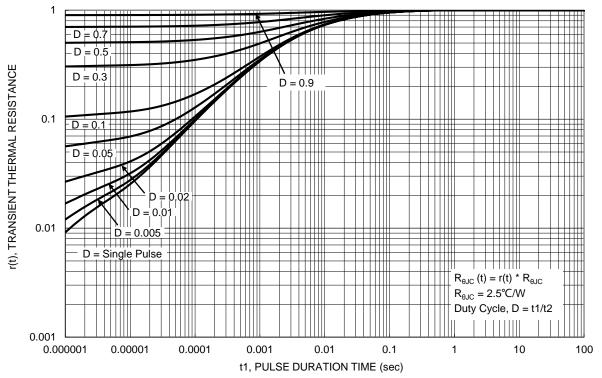


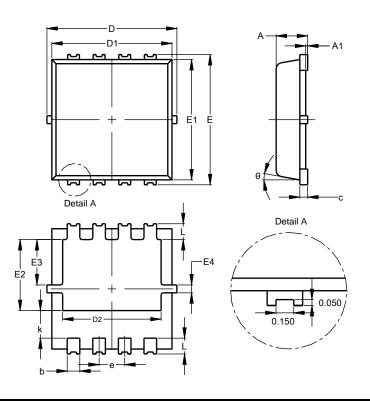
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

#### PowerDI3333-8 (SWP) (Type UX)

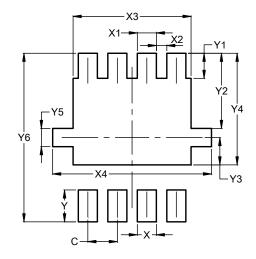


PowerDI3333-8 (SWP)					
(Type UX) ´					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05			
b	0.25	0.40	0.32		
С	0.10	0.25	0.15		
D	3.20	3.40	3.30		
D1	2.95	3.15	3.05		
D2	2.30	2.70	2.50		
Е	3.20	3.40	3.30		
E1	2.95	3.15	3.05		
E2	1.60	2.00	1.80		
E3	0.95	1.35	1.15		
E4	0.10	0.30	0.20		
е	_	_	0.65		
k	0.50	0.90	0.70		
L	0.30	0.50	0.40		
θ	0°	12°	10°		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8 (SWP) (Type UX)



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
Х3	2.600
X4	3.500
Υ	0.700
Y1	0.550
Y2	1.650
Y3	0.600
Y4	2.450
Y5	0.400
Y6	3.700



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